

(1.27 mm) .050"

**CLP SERIES** 

# N-PROFILE DUAL WIPE SOCKET

### **SPECIFICATIONS**

For complete specifications and recommended PCB layouts see www.samtec.com?CLP

### Insulator Material:

Black Liquid Crystal Polymer Contact Material: Phosphor Bronze

Plating: Sn or Au over 50 μ" (1.27 μm) Ni Current Rating (CLP/FTSH):

## 3.4 A per pin

(2 pins powered)

Voltage Rating:
240 VAC/340 VDC

# Operating Temp Range: -55 °C to +125 °C Insertion Depth:

Insertion Depth:
Top Entry = (1.40 mm) .055"
minimum, Bottom Entry =
(2.41 mm) .095" minimum
plus board thickness
DH Entry = (2.31 mm) .091"
to (2.67 mm) .105"
Normal Force:
60 grams (0.59 N) average
Max Cycles:

Max Cycles: 100 with 10 µ" (0.25 µm) Au RoHS Compliant:

### **PROCESSING**

Lead-Free Solderable:

SMT Lead Coplanarity: (0.10 mm) .004" max (02-35) (0.15 mm) .006" max (36-50)\*

(.004" stencil solution may be available; contact IPG@samtec.com)

### **RECOGNITIONS**

For complete scope of recognitions see www.samtec.com/quality



### ALSO AVAILABLE (MOQ Required)

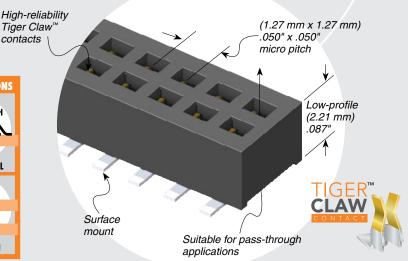
- · Single row
- · Other platings Contact Samtec.

Some sizes, styles and options are non-standard, non-returnable.

## Mates with: TSH, FTS, FW



02 thru 50





−F

= Gold flash on

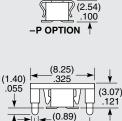
contact, Matte

Tin on tail

# **OPTION**

### –D = Double Row

-DH = Double FTSH-01 and



.035 DÍA

\_(7.00) →

PA OPTION

## = (4.00 mm) .157" DIA Polyimide film Pick & Place Pad (5 positions min.) −P

= Pick & Place Pad (5 positions min. -D only) (Not always necessary for auto placement. See Flex Processing.)

**OTHER** 

**OPTION** 

-BE

= Bottom Entry

(Required for bottom entry

applications)

= Alignment Pin

(Not available with –PA option) (05, 06, 07, 08, 10, 12, 15,

20, 25, 30, 40 positions only)

(-DH option and other sizes.

Contact Samtec.)

-PA = Pick & Place Pad with Alignment Pin (–D only) (Not Available with –A option)

> -TR = Tape & Reel

### 10 μ" (0.25 μm) Horizontal Gold on contact (Requires Matte Tin on tail ٠G FTSH-04 No. of Positions x (1.27) .050 + (0.43) .017 10 μ" (0.25 μm) lead styles) Gold -- (0.41) -- 016 02 (-D only) 100 .050 (6.35).250 (4.57) (3.05) .180 .120 (4.32) x (3.18) 170 (1.27).050 (3.43)

PIN/ROW (3.56) 140 04-15 16-50 (7.11) .280

-DH

If odd pins/row, alignment pins are on middle position on centerline of the part. If even pins/row, then alignment pins are between middle two positions.

(2.29)

.090

-D

Due to technical progress, all designs, specifications and components are subject to change without notice.